

02-06-01

A

1c952 U.S. PTO
02/05/01

Case Docket No. 11001.070

Date: February 5, 2001

Box Patent Application
ASSISTANT COMMISSIONER FOR PATENTS
Washington, D.C. 20231

1c979 U.S. PTO
09/777072
02/05/01

Sir:

Transmitted herewith for filing is the patent application of

Inventors: Ilkka Rata

For: COMPOSITE BLADE AND A METHOD FOR ITS MANUFACTURE

Enclosed are:

- ☒ 3 sheets of drawings.
- ☒ An assignment of the invention to Metso Paper, Inc.
- ☒ A certified copy of a Finnish priority application No. FI 20000254 filed February 8, 2000.
- ☒ A power of attorney.
- ☒ A Declaration for Patent Application pursuant to C.F.R. 1.63 and 1.68.
- ☐ A Verified Statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.27.
- ☐ PTO Form 1449 with copies of patents cited in Finnish Search Report.

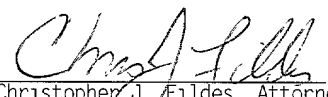
The filing fee has been calculated as shown below:

| For: | (Col.1) No. Filed | (Col.2) No. Extra | Small Entity Rate | Fee | Other Than A Small Entity Rate | Fee |
|-------------------------------------|----------------------|----------------------|----------------------|----------|--------------------------------------|-----------|
| Basic Fee | | | | \$355.00 | | \$710.00 |
| Total Claims | 10 - 20 | x 0 | x09 = | | x18 = | |
| Indep. Claims | 2 - 3 | x 0 | x40 = | | x80 = | |
| Multiple Dependent Claims Presented | | | +135 = | | +270 = | |
| Assignment Recordal Fee | | | | | | \$ 40.00 |
| | | | TOTAL | | TOTAL | \$ 750.00 |

☒ A check in the amount of \$ 750.00 to cover the filing fee is enclosed.

Respectfully submitted,

FILDES & OUTLAND, P.C.


 Christopher J. Fildes, Attorney
 Registration No. 32,132
 20916 Mack Avenue, Suite 2
 Grosse Pointe Woods, MI 48236
 (313) 885-1500

"Express Mail" mailing label No. EK016632773US
 Date of Deposit: February 5, 2001

I hereby certify that this paper or fee is
 being deposited with the United States Postal
 Service "Express Mail Post Office to
 Addressee" service under 37 C.F.R. 1.10 on
 the date indicated above and is addressed to
 the Assistant Commissioner for Patents,
 Washington, D.C. 20231.

